

# **Bond Release Submission**

## **Deadline Dates for 2026**

The Engineering Department must receive your bond release request in the proper format and with the appropriate paperwork by:

<b>Request Deadline By</b>	<b>For BOS Meeting On</b>
January 15, 2026	January 22, 2026
February 12, 2026	February 26, 2026
March 12, 2026	March 26, 2026
April 16, 2026	April 30, 2026
May 14, 2026	May 28, 2026
June 11, 2026	June 25, 2026
July 16, 2026	July 30, 2026
August 13, 2026	August 27, 2026
September 10, 2026	September 24, 2026
October 15, 2026	October 29, 2026
**November 12, 2026	November 19, 2026 (final for 2026)

**\*\*NOTE: With the Holiday & Final meeting of 2026, earlier bond release request deadlines**

